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PATENT 29926/38060

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Sung-Kwon Lee and
Sang-Ik Kim
Serial No.: 10/066,849
Filed: February 4, 2002
For: Method for Manufacturing Multi-Level Interconnections with Dual
Damascene Process
Group Art Unit: 1756
Examiner: John S. Ruggles

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I hereby certify that this paper and the documents referred to as enclosed therewith are being deposited with the United States Postal Service as first class mail, postage prepaid, on April 26, 2004, in an envelope addressed to Commissioner for Patents, P.O. Box 1450 Alexandria, Virginia 22313-1450

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AMENDMENT AFTER FINAL (37 C.F.R. § 1.116)

Mailstop AF Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

In response to the final office action mailed on February 25, 2004, please amend the above-identified patent application as follows.

Amendments to the specification begin on page 2 of this paper.

Amendments to the claims begin on page 4 of this paper.

Amendments to the abstract begin on page 7 of this paper.

Remarks begin on page 8 of this paper.